

Fast CMOS Clock Driver
Product Features:

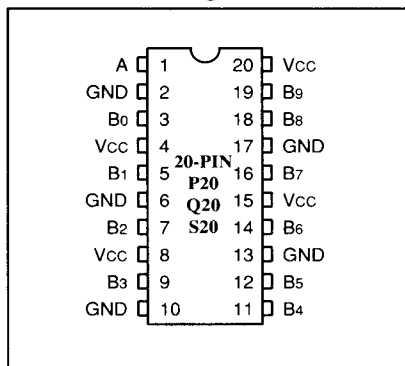
- Guaranteed low skew: 0.5 ns
- Low input capacitance
- Minimum duty cycle distortion
- 1:10 fanout
- High speed: 3.5 ns propagation delay
- TTL input and output compatible
 - $V_{OH} = 3.3V$ (typ.)
 - $V_{OL} = 0.3V$ (typ.)
- Radiation Tolerant and Radiation Enhanced versions of product also available
- Packaged in 20-pin plastic DIP, surface mount SOIC, or the industry's new "1/4 size" surface mount QSOP

Product Description:

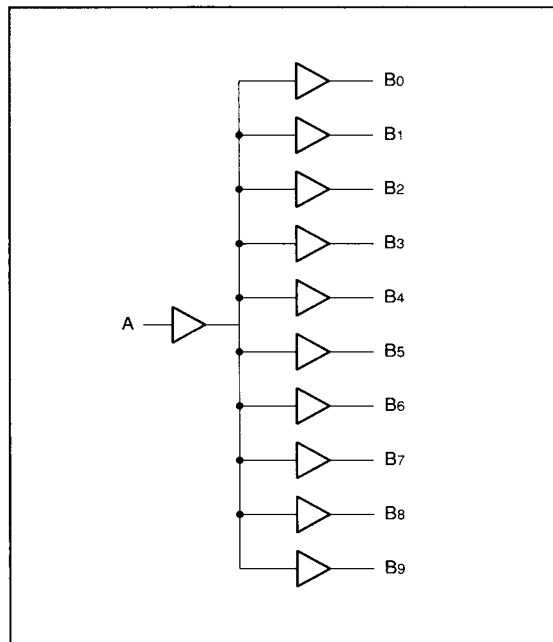
Pericom Semiconductor's PI74FCT series of logic circuits are produced in the Company's advanced 0.8 micron CMOS technology, achieving industry leading speed grades.

This low skew clock driver features one input and ten outputs fanout. The large fanout from a single input line reduces loading on input clock. TTL level outputs reduce noise levels on the part. Typical applications are clock and signal distribution.

This product is available in three package types: 20-pin, 300 mil wide plastic DIP, 300 mil wide plastic SOIC, and the industry's new 150 mil wide QSOP (one quarter the size of an SOIC).

Product Pin Configuration

Product Pin Description

Pin Name	Description
A	Input
B0 – B9	Outputs
GND	Ground
Vcc	Power

Logic Block Diagram


Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature	-65°C to +150°C
Ambient Temperature with Power Applied	0°C to +70°C
Supply Voltage to Ground Potential (Inputs & Vcc Only)	-0.5V to +7.0V
Supply Voltage to Ground Potential (Outputs & D/O Only)	-0.5V to Vcc
DC Input Voltage	-0.5V to +7.0V
DC Output Current	120 mA
Power Dissipation	0.5W

Note:

Stresses greater than those listed under **MAXIMUM RATINGS** may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

DC Electrical Characteristics (Over the Operating Range, TA = 0°C to +70°C, VCC = 5.0V ± 5%)

Parameters	Description	Test Conditions ⁽¹⁾	Min.	Typ ⁽²⁾	Max.	Units
VOH	Output HIGH Voltage	VCC = Min., VIN = VIH or VIL IOH = -15.0 mA	2.4	3.3		V
			2.0	3.0		V
VOL	Output LOW Current	VCC = Min., VIN = VIH or VIL IOL = 48 mA		0.2	0.5	V
VIH	Input HIGH Voltage	Guaranteed Logic HIGH Level	2.0			V
VIL	Input LOW Voltage	Guaranteed Logic LOW Level			0.8	V
IIH	Input HIGH Current	VCC = Max., VIN = 2.7 V			5	μA
IIL	Input LOW Current	VCC = Max., VIN = 0.5 V			-5	μA
IOZH	High Impedance	VCC = Max., VOUT = 2.7 V			+10	μA
IOZL	Output Current	VOUT = 0.5 V			-10	μA
II	Input HIGH Current	VCC = Max., VIN = VCC (Max.)			20	μA
VIK	Clamp Diode Voltage	VCC = Min., IIN = -18 mA		-0.7	-1.2	V
IOS	Short Circuit Current	VCC = Max. ⁽³⁾ , VOUT = GND	-60	-120	-225	mA
IOFF	Power Down Disable	VCC = GND, VOUT = 4.5 V	—	—	100	μA
VH	Input Hysteresis			150		mV

Capacitance (TA = 25°C, f = 1 MHz)

Parameters ⁽⁴⁾	Description	Test Conditions	Typ	Max.	Units
CIN	Input Capacitance	VIN = 0 V	6.0	6.0	pF
COUT	Output Capacitance	VOUT = 0 V	8	12	pF

Notes:

- For conditions show as Max. or Min., use appropriate value specified under Electrical Characteristics for the applicable device type.
- Typical values are at VCC = 5.0, +25°C ambient and maximum loading.
- Not more than one output should be shorted at one time. Duration of the test should not exceed one second.
- This parameter is determined by device characterization but is not production tested.

Power Supply Characteristics

Parameters	Description	Test Conditions ⁽¹⁾		Min.	Typ ⁽²⁾	Max.	Units
I _{cc}	Quiescent Power Supply Current	V _{CC} = Max.	V _{IN} = GND or V _{CC}		0.2	1.5	mA
ΔI _{cc}	Supply Current per Input @ TTL HIGH	V _{CC} = Max.,	V _{IN} = 3.4 V ⁽³⁾		0.5	1.5	mA
I _{CCD}	Supply Current per Input per MHz ⁽⁴⁾	V _{CC} = Max., Outputs Open 50% Duty Cycle, One Input Toggling	V _{IN} = V _{CC} V _{IN} = GND		0.4	0.6	mA/ MHz
I _c	Total Power Supply Current ⁽⁶⁾	V _{CC} = Max., Outputs Open f _{CP} = 50 MHz, 50% Duty Cycle, One Bit toggling at f _i = 5 MHz	V _{IN} = V _{CC} V _{IN} = GND		20	30 ⁽⁵⁾	mA
			V _{IN} = 3.4 V V _{IN} = GND		20.7	33 ⁽⁵⁾	

Notes:

- For conditions shown as Max. or Min., use appropriate value specified under Electrical Characteristics for the applicable device.
- Typical values are at V_{CC} = 5.0 V, +25°C ambient.
- Per TTL driven input (V_{IN} = 3.4 V); all other inputs at V_{CC} or GND.
- This parameter is not directly testable, but is derived for use in Total Power Supply Calculations.
- Values for these conditions are examples of the I_{cc} formula. These limits are guaranteed but not tested.
- I_C = I_{QUIESCENT} + I_{INPUTS} + I_{DYNAMIC}
 $I_C = I_{CC} + \Delta I_{CC} D_H N_T + I_{CCD} (f_{CP}/2 + f_i N_i)$
 I_{CC} = Quiescent Current
 ΔI_{CC} = Power Supply Current for a TTL High Input (V_{IN} = 3.4 V)
 D_H = Duty Cycle for TTL Inputs High
 N_T = Number of TTL Inputs at D_H
 I_{CCD} = Dynamic Current Caused by an Input Transition Pair (HLH or LHL)
 f_{CP} = Clock Frequency for Register Devices (Zero for Non-Register Devices)
 f_i = Input Frequency
 N_i = Number of Inputs at f_i
 All currents are in milliamps and all frequencies are in megahertz.

Switching Characteristics over Operating Range

Parameters	Description	Conditions ⁽¹⁾	FCT807T		FCT807BT		FCT807CT		Unit
			Com.		Com.		Com.		
			Min	Max	Min	Max	Min	Max	
tPLH	Propagation Delay	Zo = 50Ω with Thevenin termination (See Figure c) or with AC termination (See Figure d) f ≤ 100MHz Outputs ganged in groups of two	1.5	4.5	1.5	3.5	1.5	3.5	ns
tPHL	A to B _N								
tSKIOI	Skew between two outputs of same package ⁽³⁾			0.5		0.5		0.25	ns
tSKIPi	Skew between opposite transitions of same output ((tPHL — tPLH)/) ⁽³⁾		0.5		0.5		0.35	ns	
tSKII	Skew between outputs of different package at same power supply, temperature and speed grade ⁽⁵⁾		—	1.0	—	1.0		0.75	ns

Notes:

- See test circuit and wave forms.
- Minimum limits are guaranteed but not tested on Propagation Delays.
- This parameter is guaranteed but not tested.

Switching Characteristics over Operating Range

Parameters	Description	Conditions ⁽¹⁾	FCT807T		FCT807BT		FCT807CT		Unit
			Com.		Com.		Com.		
			Min	Max	Min	Max	Min	Max	
tPLH tPHL	Propagation Delay A to B _N	CL = 30 pF t ≤ 67MHz (See Figure b)	1.5	4.5	1.5	3.8	1.5	3.5	ns
tSK(o)	Skew between two outputs of same package ⁽³⁾			0.5		0.5		0.25	ns
tSK(p)	Skew between opposite transitions of same output (/tPHL — tPLH/) ⁽³⁾			0.5		0.5		0.35	ns
tSK(i)	Skew between outputs of different package at same power supply, temperature and speed grade ⁽³⁾		—	1.0	—	0.9		0.75	ns

Switching Characteristics over Operating Range

Parameters	Description	Conditions ⁽¹⁾	FCT807T		FCT807BT		FCT807CT		Unit
			Com.		Com.		Com.		
			Min	Max	Min	Max	Min	Max	
tPLH	Propagation Delay A TO B _N	C _L = 50 pF t ≤ 40MHz (See Figure a)	1.5	4.5	1.5	3.8	1.5	3.5	ns
tSK(o)	Skew between two outputs of same package ⁽³⁾			0.5		0.5		0.25	ns
tSK(p)	Skew between opposite transitions of same output (/tPHL — tPLH/) ⁽³⁾			0.5		0.5		0.35	ns
tSK(i)	Skew between outputs of different package at same power supply, temperature and speed grade ⁽³⁾		—	1.0	—	1.0		0.75	ns

Notes:

1. See test circuit and wave forms.
2. Minimum limits are guaranteed but not tested on Propagation Delays.
3. This parameter is guaranteed but not tested.

Test Circuits and Waveforms

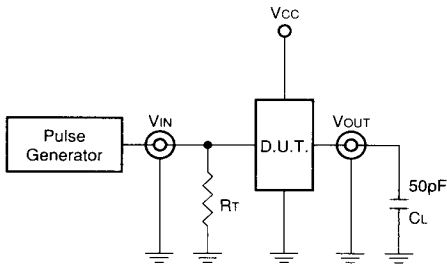


Figure a

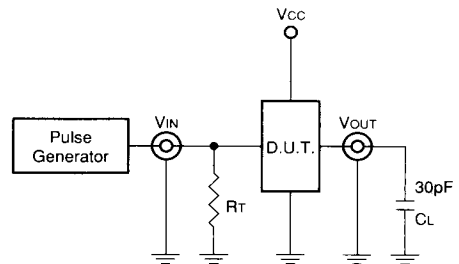


Figure b

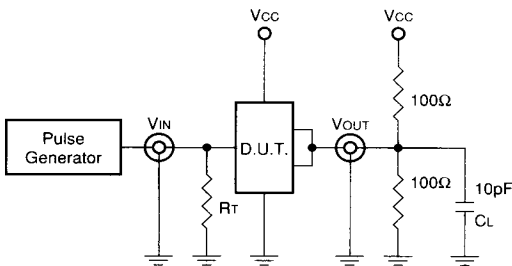


Figure c

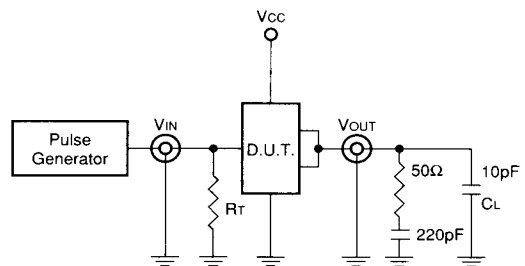
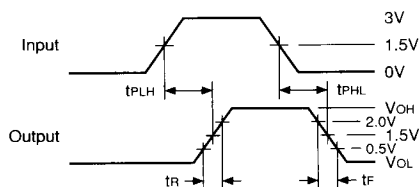


Figure d

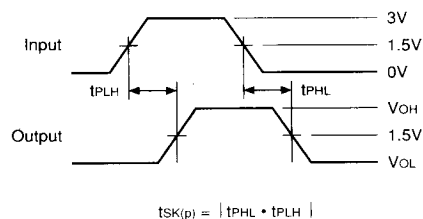
The capacitor value for AC termination is determined by the operation frequency. For very low frequencies a higher capacitor value should be selected.

Test Circuits and Waveforms (Continued)

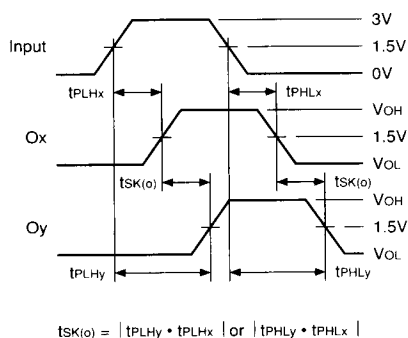
Propagation Delay



Pulse Skew – tSK(p)



Output Skew – tSK(o)



Package Skew – tSK(i)

